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#### FEATURES

- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V<sub>CC</sub> Supply
- **Operates at Least 1 Mbit/s**
- Low Standby Current ... 1 µA Typ
- External Capacitors . . .  $4 \times 0.1 \ \mu F$
- Accepts 5-V Logic Input With 3.3-V Supply
- Designed to Be Interchangeable With Maxim™ **MAX3227E**
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection for RS-232 I/O Pins
  - ±15 kV Human-Body Model
  - ±8 kV IEC61000-4-2, Contact Discharge
  - ±15 kV IEC61000-4-2, Air-Gap Discharge
- **Auto-Powerdown Plus Feature Automatically Disables Drivers for Power Savings**
- Packaged in Plastic Shrink Small-Outline Package

### DESCRIPTION/ORDERING INFORMATION

#### APPLICATIONS

- Battery-Powered, Hand-Held, and Portable Equipment
- PDAs and Palmtop PCs
- Notebooks, Sub-Notebooks, and Laptops
- **Digital Cameras**
- **Mobile Phones and Wireless Devices**



The MAX3227E consists of one line driver, one line receiver, and a dual charge-pump circuit with ±15-kV IEC ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. This device operates at data-signaling rates of 1 Mbit/s in normal operating mode and a maximum of 30-V/µs driver output slew rate. This device also features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The MAX3227E achieves a 1-µA supply current using the auto-powerdown plus feature. This device automatically enters a low-power powerdown mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. They turn on again when they sense a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

The MAX3227EC is characterized for operation from 0°C to 70°C. The MAX3227EI is characterized for operation from -40°C to 85°C.

T <sub>A</sub>	P	ACKAGE <sup>(1)(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°0 to 70°0		Tube of 80	MAX3227ECDB	MD007E0
0°C to 70°C	SSOP – DB	Reel of 2000	MAX3227ECDBR	MP227EC
40°C to 95°C	SSOP – DB	Tube of 80	MAX3227EIDB	MP227FI
–40°C to 85°C	550P - DB	Reel of 2000	MAX3227EIDBR	WIP227EI

#### **ORDERING INFORMATION**

(1) Package drawings, standard packing guantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI (2)website at www.ti.com.



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W	INPUT CO	NDITIONS	WT		OUTPUT	STATES	WT I	
FORCEON	FORCEOFF	RECEIVER OR DRIVER EDGE WITHIN 30 s	VALID RS-232 LEVEL PRESENT AT RECEIVER	DRIVER	RECEIVER	INVALID	READY	OPERATING MODE
-01×-	N N	WWW.	Auto-	Powerdow	n Plus Condi	tions	1.00	WTD
CH	н	NO	NO	Active	Active	L 10	N.HOM	Normal operation, auto-powerdown plus disable
Y.CH	TWH	NO	YES	Active	Active	H <sub>V</sub> .1	NO H	Normal operation, auto-powerdown plus disable
OY L	HT.I	YES	NO	Active	Active	LN.	H I	Normal operation, auto-powerdown plus enable
	Н	YES	YES	Active	Active	H	H	Normal operation, auto-powerdown plus enable
In Far.	OM H	NO	NO	z	Active	AW	N.1400	Powerdown, auto-powerdown plus enable
tory.	H.TW	NO 🚿	YES	z	Active	HNY	L.10	Powerdown, auto-powerdown plus enable
X	LIT	Х	NO	Z	Active	LV	L	Manual powerdown
X	V.COm	X	YES	Z	Active	H 🗸		Manual powerdown
W.IV	COM.		Au	to-Powerde	own Conditio	ns	WWW.	No.COM.
INVALID	INVALID	x	NO	Z	Active	L	WYW	Powerdown, auto-powerdown enabled
INVALID	INVALID	x	YES	Active	Active	АН	H	Normal operation, auto-powerdown enabled

(1) H = high level, L = low level, X = irrelevant, Z = high impedance WWW.100Y.CO WWW.100Y.COM.TW WWW.

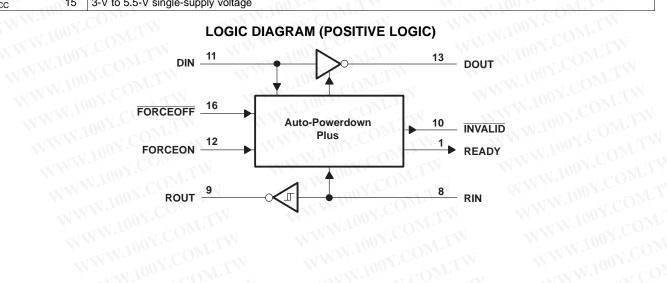
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#### **TERMINAL FUNCTIONS**

TERMINA	۹L	DECODIDITION
NAME	NO.	DESCRIPTION
C1+	2	Positive terminal of voltage-doubler charge-pump capacitor
C1-	4	Negative terminal of voltage-doubler charge-pump capacitor
C2+	5	Positive terminal of inverting charge-pump capacitor
C2–	6	Negative terminal of inverting charge-pump capacitor
DIN	11	CMOS driver input
DOUT	13	RS-232 driver output
FORCEOFF	16	Force-off input, active low. Drive low to shut down drivers, receivers, and charge pump. This overrides auto-shutdow and FORCEON (see Function Table).
FORCEON	12	Force-on input, active high. Drive high to override powerdown, keeping drivers and receivers on (FORCEOFF must be high) (see Function Table).
GND	14	Ground
INVALID	10	Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input
READY	1	Ready to transmit output, active high. READY is enabled high when V- goes below -3.5 V and the device is ready transmit.
RIN	8	RS-232 receiver input
ROUT	9	CMOS receiver output
V+	3	$+2 \times V_{CC}$ generated by the charge pump
V-	7	$-2 \times V_{CC}$ generated by the charge pump
V <sub>CC</sub>	15	3-V to 5.5-V single-supply voltage



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#### Absolute Maximum Ratings<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>	CONT	-0.3	6	V
V+	Positive output supply voltage range <sup>(2)</sup>	IN WY 1002.	-0.3	7	V
V–	Negative output supply voltage range <sup>(2)</sup>	TW WWWWWWY.CO	0.3	-7	V
V+ - V-	Supply voltage difference <sup>(2)</sup>	N.WWW.LO	Wn	13	V
	1002	Driver (FORCEOFF, FORCEON)	-0.3	6	V
ViCO	Input voltage range	Receiver	-25	25	V
SI CO	Output to the second se	Driver	-13.2	13.2	
Vo	Output voltage range	Receiver (INVALID, READY)	-0.3	V <sub>CC</sub> + 0.3	V
04.0	Short-circuit duration	DOUT to GND	COM.	Unlimited	
θ <sub>JA</sub>	Package thermal impedance <sup>(3)</sup>	INTH WILLION	.M.I	82	°C/W
	Lead temperature 1,6 mm (1/16 in) from case	e for 10 s	N.Com	260	°C
T <sub>stg</sub>	Storage temperature range	CONT.	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltages are with respect to network GND. (2)

(3) The package thermal impedance is calculated in accordance with JESD 51-7.

#### **Recommended Operating Conditions**<sup>(1)</sup>

#### See Figure 5

A.	100 1. COM. 1	M.100 . COM	WW.	MIN	NOM	MAX	UNIT
N	Supply voltage	1001. M.I.W.	V <sub>CC</sub> = 3.3 V	3	3.3	3.6	V
	Supply voltage		$V_{CC} = 5 V$	4.5	5	5.5	V
V	Driver and central high level input veltage	DIN, FORCEOFF, FORCEON	V <sub>CC</sub> = 3.3 V	2	V.C	5.5	V
V <sub>IH</sub>	Driver and control high-level input voltage	DIN, FORCEOFF, FORCEON	$V_{CC} = 5 V$	2.4	1	5.5	v
VIL	Driver and control low-level input voltage	DIN, FORCEOFF, FORCEON	N N	0	)0 r.	0.8	V
VI	Receiver input voltage	WWWWWWWWWW	W WT	-25	1001	25	V
<b>-</b>		NWW.102 COM	MAX3227EC	0		70	
T <sub>A</sub>	Operating free-air temperature		MAX3227EI	-40	1.700	85	°C

WW.100Y.CON (1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

	PARA	METER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
I <sub>I</sub>	Input leakage current	FORCEOFF, FORCEON	WWW 100Y.CO.LT	1	±0.01	±1	μA
	WWY	Auto-powerdown plus disabled	No load, FORCEOFF and FORCEON at $V_{CC}$	LAI	0.3	2	mA
امم	Supply current	Powered off	No load, FORCEOFF at GND	N	1	10	1100
ICC	(T <sub>A</sub> = 25°C)	Auto-powerdown plus enabled	No load, FORCEOFF at V <sub>CC</sub> , FORCEON at GND, All RIN are open or grounded	N.T.W	1	10	μA

(2) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}C$ .

#### **DRIVER SECTION**

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

Mo	PARAMETER	TEST C	ONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
VOH	High-level output voltage	DOUT at $R_L = 3 k\Omega$ to GND,	DIN = GND	5	5.4		V
V <sub>OL</sub>	Low-level output voltage	DOUT at $R_L = 3 k\Omega$ to GND,	$DIN = V_{CC}$	-5	-5.4		V
Ін	High-level input current	$V_{I} = V_{CC}$	WWWWWWWWWWWW	WT	±0.01	±1	μA
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> at GND	CON CON	AV.	±0.01	±1	μA
14.0	Short-circuit output current <sup>(3)</sup>	$V_{CC} = 3.6 V,$	$V_0 = 0 V$	V.L.	±35	±60	٣A
IOS	Short-circuit output current.	$V_{CC} = 5.5 V,$	$V_0 = 0 V$	TIM	±35	±60	mA
r <sub>o</sub>	Output resistance	$V_{CC}$ , V+, and V– = 0 V,	$V_0 = \pm 2 V$	300	10M		Ω
I <sub>off</sub>	Output leakage current	FORCEOFF = GND,	$V_0 = \pm 12 \text{ V},  V_{CC} = 0 \text{ to } 5.5 \text{ V}$	ON.		±25	μA

(1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}C$ . (2)

(3) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

#### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

	PARAMETER	T.W.	EST CONDITIONS	VIII	MIN	TYP <sup>(2)</sup> MAX	UNIT
AN A	W.100Y.COM.	C <sub>L</sub> = 1000 pF, One DIN switching,	$R_L = 3 k\Omega$ , See Figure 1	WW W	250	N.COM.T	N
	Maximum data rate	$C_{L} = 1000 \text{ pF},$ $V_{CC} = 4.5 \text{ V},$	$R_L = 3 k\Omega$ , See Figure 1	One DIN switching,	1000	NOY.CONL	kbit/s
		$C_{L} = 250 \text{ pF},$ $V_{CC} = 3 \text{ V},$	$R_L = 3 k\Omega,$ See Figure 1	One DIN switching,	1000	100Y.COM	WT.
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	$C_{L} = 150 \text{ pF to } 2500 \text{ pF},$	$R_L = 3 k\Omega \text{ to } 7 k\Omega$ ,	See Figure 2	111	25	ns
SR(tr)	Slew rate, transition region	$V_{CC} = 3.3 V,$ $C_L = 150 \text{ pF to } 1000 \text{ pF},$	$R_L = 3 k\Omega$ to 7 kΩ, See Figure 1	WI.IW	24	150	V/µs

WWW.100Y.COM Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V. (1)

(2)

All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C. Pulse skew is defined as  $|t_{PLH} - t_{PHL}|$  of each channel of the same device. (3)

#### ESD Protection

TERMIN	AL	W. 100 J COMPANY TEAT AND TO AND THE WAY	TVD	V.C.
AME	NO.	TEST CONDITIONS	ТҮР	UNIT
	N	Human-Body Model	±15	JO 7
JUT	13	Contact Discharge (IEC61000-4-2)	±8	kV
		Air-Gap Discharge (IEC61000-4-2)	±15	

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#### RECEIVER SECTION

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 3)

) MA	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
V <sub>он</sub>	High-level output voltage	$I_{OH} = -1 \text{ mA}$	$V_{\rm CC} - 0.6$	V <sub>CC</sub> - 0.1		V
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 1.6 mA	COM.		0.4	V
	Desitive geing input threshold voltage	$V_{CC} = 3.3 V$	M.T.	1.5	2.4	V
V <sub>IT+</sub>	Positive-going input threshold voltage	$V_{CC} = 5 V$	I.V.	1.8	2.4	v
	Negative going input threshold voltage	$V_{CC} = 3.3 V$	0.6	1.2		V
V <sub>IT-</sub>	Negative-going input threshold voltage	$V_{CC} = 5 V$	0.8	1.5		v
V <sub>hys</sub>	Input hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> )	NTW WILL	100X.	0.5		V
off	Output leakage current	WWW WT	. INOY.CO.	±0.05	±10	μA
ri vo -	Input resistance	$V_1 = \pm 3 V$ to $\pm 25 V$	3	5	7	kΩ

(1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.

All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}$ C. (2)

#### Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

NN.	PARAMETER	TEST CONDITIONS	TYP <sup>(2)</sup>	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output	C <sub>L</sub> = 150 pF, See Figure 3	150	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	$C_L = 150 \text{ pF}$ , See Figure 3	150	ns
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	See Figure 3	50	ns

WWW.100Y.COM. (1) Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V ± 0.5 V.

All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}$ C. (2)

#### **ESD** Protection

TERM	INAL	TEST CONDITIONS	TVD	111117
NAME	NO.	TEST CONDITIONS	ТҮР	UNIT
	MM.	Human-Body Model	±15	M.
RIN	8	Contact Discharge (IEC61000-4-2)	±8	kV
		Air-Gap Discharge (IEC61000-4-2)	±15	COMP

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#### **AUTO-POWERDOWN SECTION**

#### **Electrical Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

	PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
V <sub>T+(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, FORCEOFF = $V_{CC}$	W	2.7	V
V <sub>T–(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, FORCEOFF = V <sub>CC</sub>	-2.7		V
V <sub>T(invalid)</sub>	Receiver input threshold for INVALID low-level output voltage	FORCEON = GND, FORCEOFF = $V_{CC}$	-0.3	0.3	V
V <sub>OH</sub>	INVALID, READY output voltage high	$I_{OH} = -1$ mA, FORCEON = GND, FORCEOFF = $V_{CC}$	$V_{\rm CC} - 0.6$		V
V <sub>OL</sub>	INVALID, READY output voltage low	$I_{OL} = 1.6 \text{ mA}, \text{ FORCEON} = \text{GND}, \overline{\text{FORCEOFF}} = V_{CC}$	M.T.Y	0.4	V

#### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

N 100Y.	PARAMETER	V. 100 *	MIN	TYP <sup>(1)</sup>	MAX	UNIT
t <sub>INVH</sub>	Propagation delay time, low- to high-level output	N N 100		M.TT	N	μs
t <sub>INVL</sub>	Propagation delay time, high- to low-level output	WWWWWWW	NI.CO	30	N	μs
t <sub>WU</sub>	Supply enable time	N.WW.IV	J C	100		μs
t <sub>AUTOPRDN</sub>	Driver or receiver edge to driver's shutdown	$V_{CC} = 5 V$	15	30	60	s
	cal values are at $V_{CC}$ = 3.3 V or $V_{CC}$ = 5 V, and $T_A$ = 25°C.	N N N N N N N N N N N N N N N N N N N	1001.	COM	TW	-

(1) All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^{\circ}$ C. WWW.100Y.COM.TW

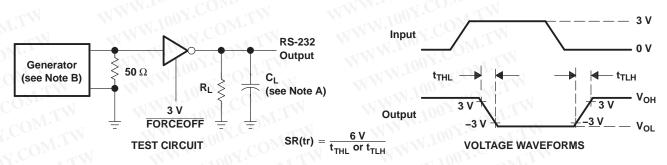
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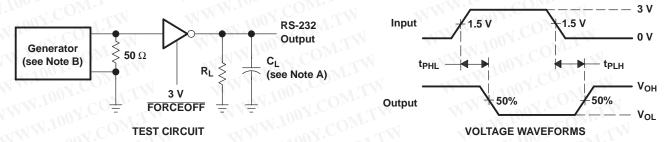


PARAMETER MEASUREMENT INFORMATION

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_0 = 50 \Omega$ , 50% duty cycle,  $t_f \le 10$  ns,  $t_f \le 10$  ns.

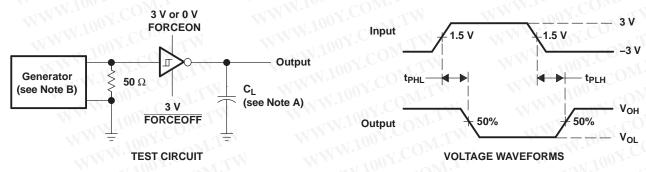
Figure 1. Driver Slew Rate



NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_0 = 50 \Omega$ , 50% duty cycle,  $t_f \le 10$  ns,  $t_f \le 10$  ns.

#### Figure 2. Driver Pulse Skew

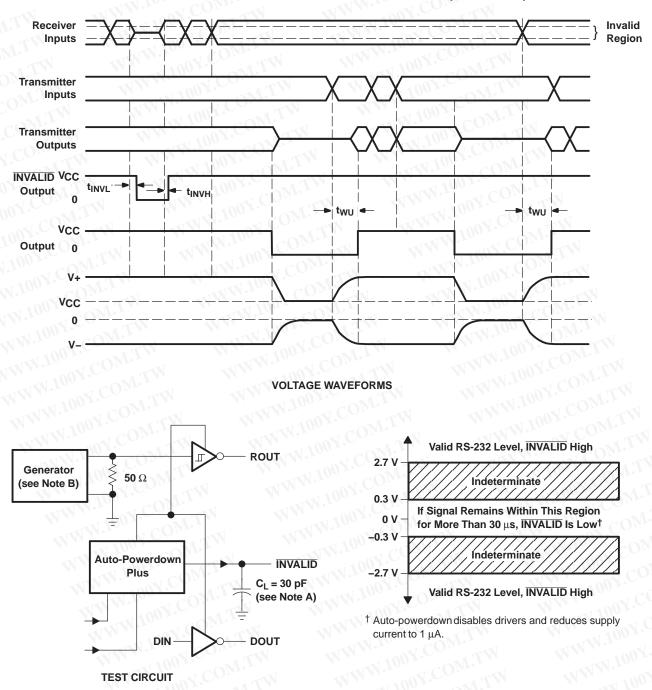


NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The pulse generator has the following characteristics:  $Z_0 = 50 \Omega$ , 50% duty cycle,  $t_r \le 10$  ns,  $t_f \le 10$  ns.

Figure 3. Receiver Propagation Delay Times

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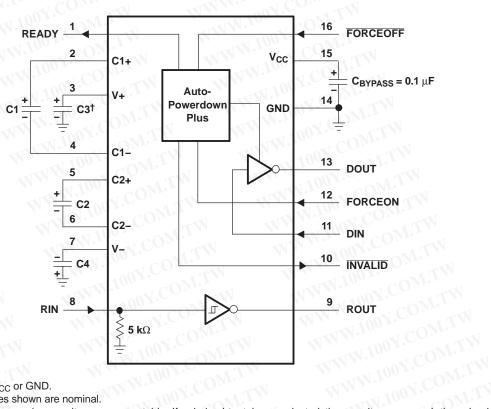


**PARAMETER MEASUREMENT INFORMATION (continued)** 





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#### **APPLICATION INFORMATION**

WWW.100Y.COM.TW <sup>†</sup> C3 can be connected to V<sub>CC</sub> or GND.

- NOTES: A. Resistor values shown are nominal.
  - B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

	Vcc	C1	C2, C3, and C4
1	$\begin{array}{c} \textbf{3.3 V} \pm \textbf{0.3 V} \\ \textbf{5 V} \pm \textbf{0.5 V} \\ \textbf{3 V to 5.5 V} \end{array}$	0.1 μF 0.047 μF 0.1 μF	0.1 μF 0.33 μF 0.47 μF

# WWW.100Y.COM.TW WWW.100Y.COM.TW Figure 5. Typical Operating Circuit and Capacitor Values WWW.100Y.CON

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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins P	ackage Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
MAX3227ECDB	ACTIVE	SSOP	DB	16	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227ECDBG4	ACTIVE	SSOP	DB	16	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227ECDBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227ECDBRG4	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227EIDB	ACTIVE	SSOP	DB	16	80	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227EIDBG4	ACTIVE	SSOP	DB	16	80 <	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227EIDBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
MAX3227EIDBRG4	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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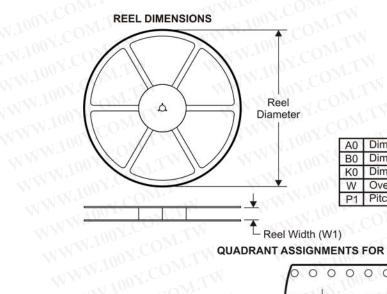
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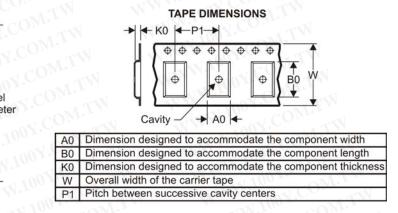
TEXAS STRUMENTS www.ti.com

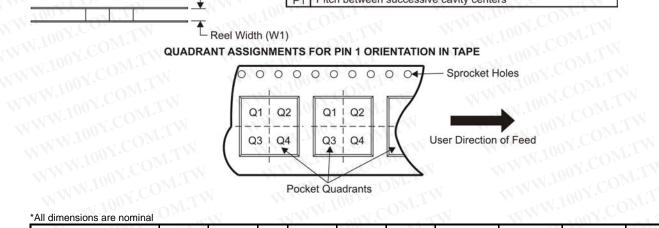
#### TAPE AND REEL INFORMATION

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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadran
MAX3227ECDBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
MAX3227EIDBR	SSOP	DB	16	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1

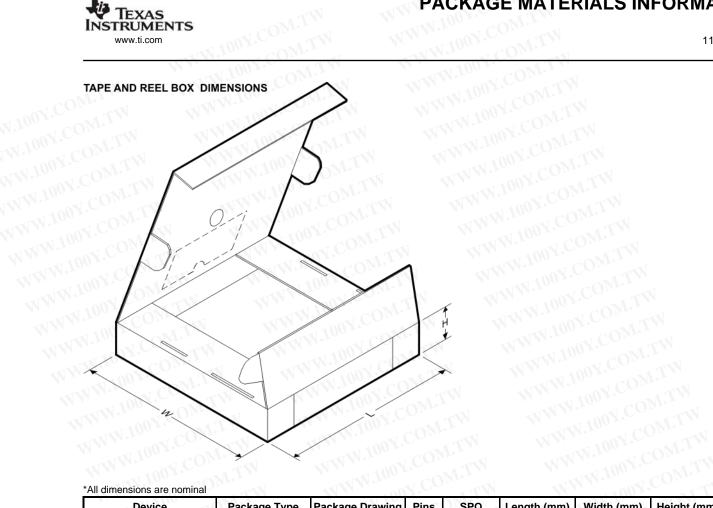
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11-Mar-2008



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	ackage Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
AX3227ECDBR	SSOP	DB	16	2000	346.0	346.0	33.0
AX3227EIDBR	SSOP	DB	16	2000	346.0	346.0	33.0

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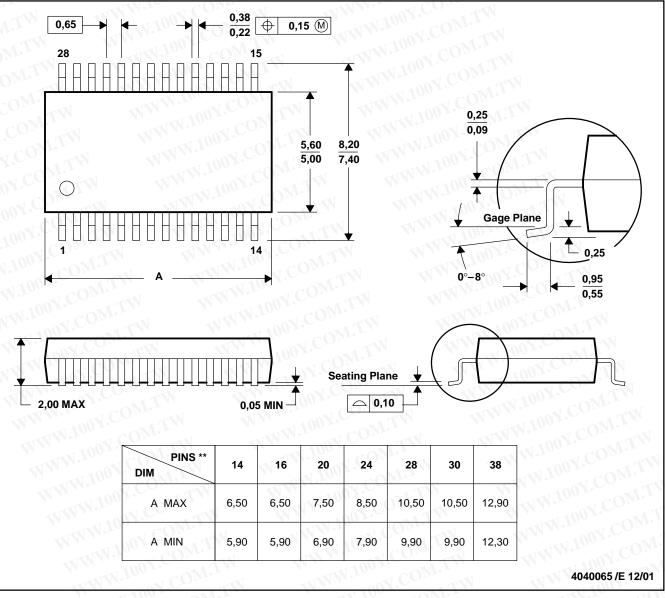
# **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

#### PLASTIC SMALL-OUTLINE

# DB (R-PDSO-G\*\*)

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150

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